

Solid State Relay OCMOS FET

PS7241-1A

4-PIN SOP 400 V BREAK DOWN VOLTAGE 1-ch Optical Coupled MOS FET

DESCRIPTION

The PS7241-1A is a solid state relay containing GaAs LEDs on the light emitting side (input side) and normally open (N.O.) contact MOS FETs on the output side.

It is suitable for analog signal control because of its low offset and high linearity.

FEATURES

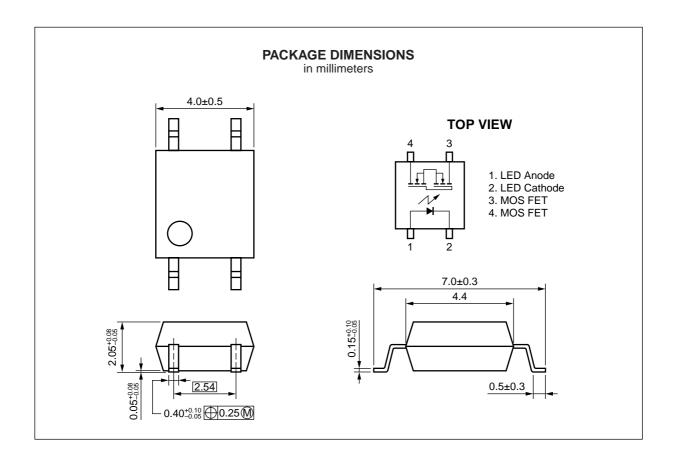
- Small and thin package (4-pin SOP, Height = 2.1 mm)
- 1 channel type (1 a output)
- Low LED operating current (IF = 2 mA)
- · Designed for AC/DC switching line changer
- · Low offset voltage
- Ordering number of taping product: PS7241-1A-E3, E4, E5, F3, F4
- UL approved: File No. E72422 (S)
- BSI approved: No. 8241/8242
- CSA approved: No. CA 101391
- ★ VDE approved: No. 121302 ÜG

APPLICATIONS

- · Laptop PC, PDA
- Modem card
- · Telephone, FAX
- · Measurement equipment

The information in this document is subject to change without notice. Before using this document, please confirm that this is the latest version.

Not all devices/types available in every country. Please check with local NEC representative for availability and additional information.





★ ORDERING INFORMATION

Part Number	Package	Packing Style	Application Part Number*1
PS7241-1A	4-pin SOP	Magazine case 100 pcs	PS7241-1A
PS7241-1A-E3		Embossed Tape 900 pcs/reel	
PS7241-1A-E4			
PS7241-1A-E5		Embossed Tape 1 000 pcs/reel	
PS7241-1A-F3		Embossed Tape 3 500 pcs/reel	
PS7241-1A-F4			

^{*1} For the application of the Safety Standard, following part number should be used.

ABSOLUTE MAXIMUM RATINGS (TA = 25 °C, unless otherwise specified)

Parameter		Symbol	Ratings	Unit	
Diode	Forward Current (DC)	lF	50	mA	
	Reverse Voltage	VR	5.0	V	
	Power Dissipation	PD	50	mW	
	Peak Forward Current*1	IFP	1	Α	
MOS FET	Break Down Voltage	VL	400	V	
	Continuous Load Current	lι	120	mA	
	Pulse Load Current ^{*2} (AC/DC Connection)	ILP	240	mA	
	Power Dissipation	Po	300	mW	
Isolation Voltage ^{*3}		BV	1 500	Vr.m.s.	
Total Power Dissipation		Рт	350	mW	
Operating Ambient Temperature		TA	-40 to +80	°C	
Storage Temperature		T _{stg}	-40 to +100	°C	

^{*1} PW = 100 μ s, Duty Cycle = 1 %

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^{*2} PW = 100 ms, 1 shot

^{*3} AC voltage for 1 minute at $T_A = 25$ °C, RH = 60 % between input and output

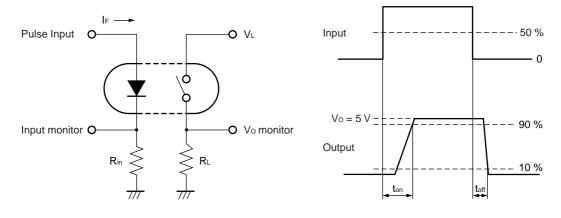
RECOMMENDED OPERATING CONDITIONS (TA = 25 °C)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
LED Operating Current	lF	2	10	20	mA
LED Off Voltage	VF	0		0.5	V

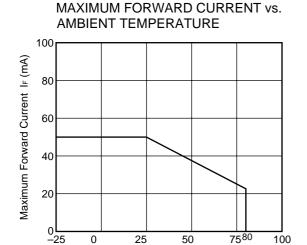
ELECTRICAL CHARACTERISTICS (TA = 25 °C)

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	VF	IF = 10 mA		1.2	1.4	V
	Reverse Current	lR	V _R = 5 V			5.0	μΑ
MOS FET	Off-state Leakage Current	Loff	V _D = 400 V		0.03	1.0	μΑ
	Output Capacitance	Cout	V _D = 0 V, f = 1 MHz		54		pF
Coupled	LED On-state Current	IFon	I _L = 120 mA			2.0	mA
	On-state Resistance	Ron1	IF = 10 mA, IL = 10 mA		18	30	Ω
		Ron2	$I_F = 10 \text{ mA}, I_L = 120 \text{ mA}, t \le 10 \text{ ms}$		15	25	
	Turn-on Time [™]	ton	I _F = 10 mA, V _O = 5 V, PW ≥ 10 ms		0.5	2.0	ms
	Turn-off Time [™]	toff			0.07	0.2	
	Isolation Resistance	R _{I-O}	V _I -O = 1.0 kV _{DC}	10°			Ω
	Isolation Capacitance	C _{I-O}	V = 0 V, f = 1 MHz		0.5		pF

★ *1 Test Circuit for Switching Time

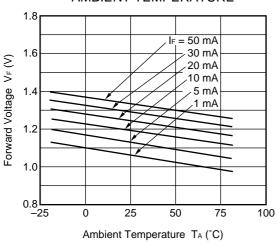


★ TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise specified)

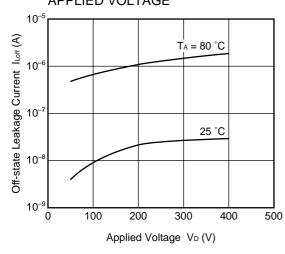


FORWARD VOLTAGE vs. AMBIENT TEMPERATURE

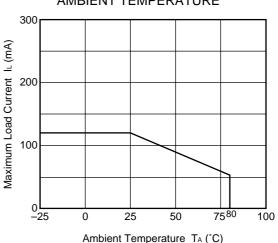
Ambient Temperature TA (°C)



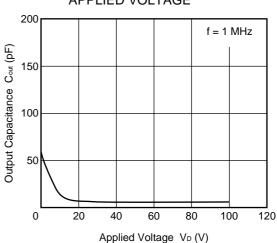
OFF-STATE LEAKAGE CURRENT vs. APPLIED VOLTAGE



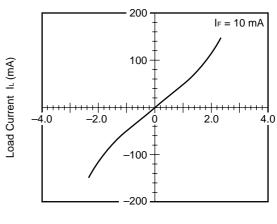
MAXIMUM LOAD CURRENT vs. AMBIENT TEMPERATURE



OUTPUT CAPACITANCE vs. APPLIED VOLTAGE



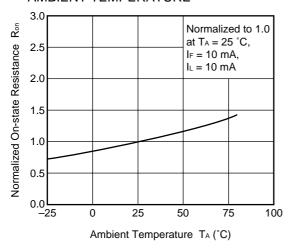
LOAD CURRENT vs. LOAD VOLTAGE



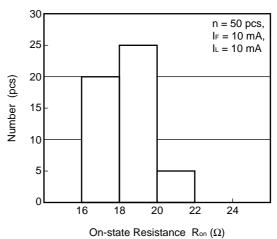
Load Voltage V_L (V)



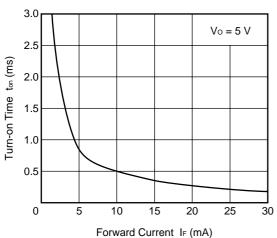
NORMALIZED ON-STATE RESISTANCE vs. AMBIENT TEMPERATURE



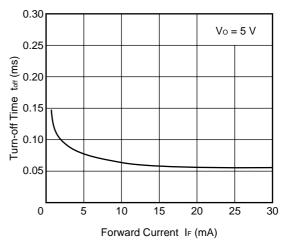
ON-STATE RESISTANCE DISTRIBUTION



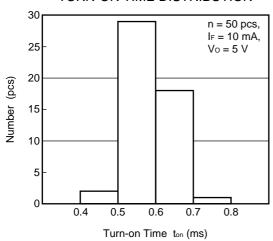
TURN-ON TIME vs. FORWARD CURRENT



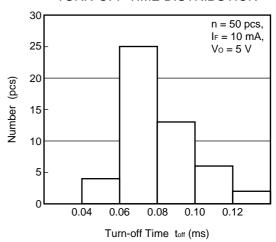
TURN-OFF TIME vs. FORWARD CURRENT



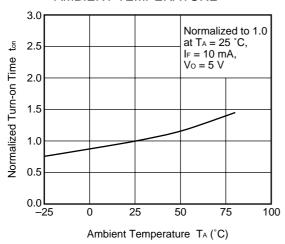
TURN-ON TIME DISTRIBUTION



TURN-OFF TIME DISTRIBUTION

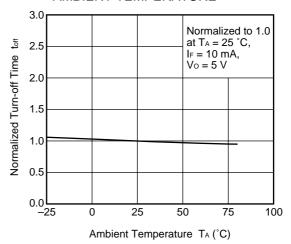


NORMALIZED TURN-ON TIME vs. AMBIENT TEMPERATURE

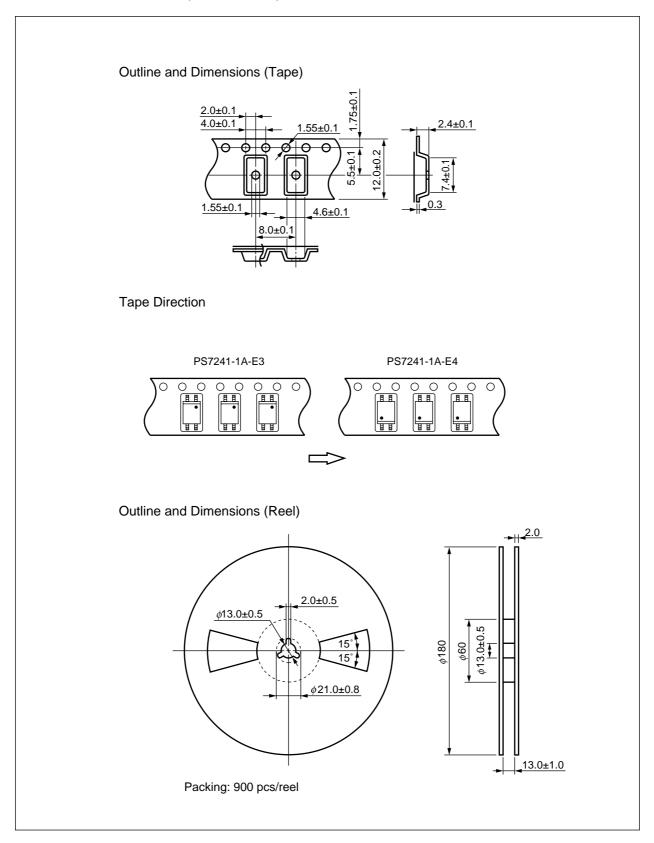


Remark The graphs indicate nominal characteristics.

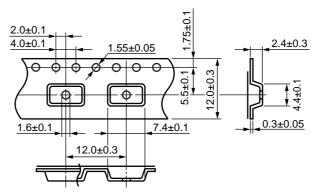
NORMALIZED TURN-OFF TIME vs. AMBIENT TEMPERATURE



★ TAPING SPECIFICATIONS (in millimeters)

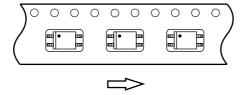


Outline and Dimensions (Tape)

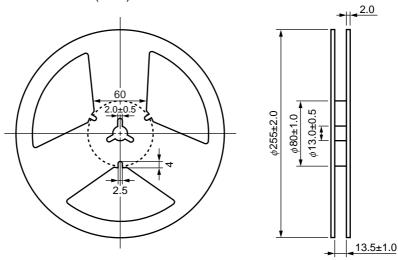


Tape Direction

PS7241-1A-E5

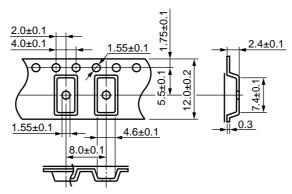


Outline and Dimensions (Reel)

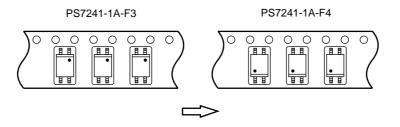


Packing: 1 000 pcs/reel

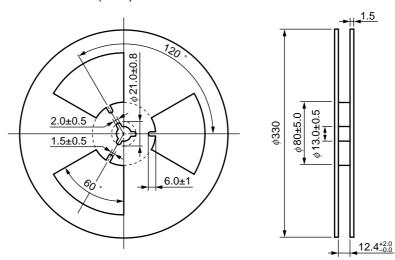
Outline and Dimensions (Tape)



Tape Direction



Outline and Dimensions (Reel)



Packing: 3 500 pcs/reel



* RECOMMENDED SOLDERING CONDITIONS

(1) Infrared reflow soldering

• Peak reflow temperature 235 °C (package surface temperature)

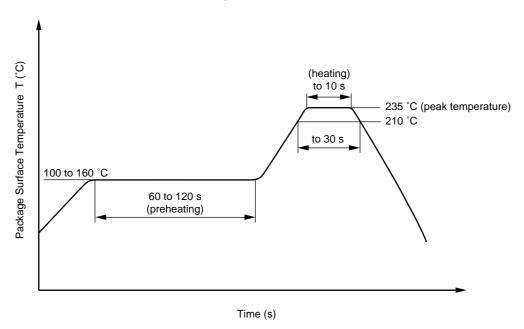
• Time of temperature higher than 210 °C 30 seconds or less

• Number of reflows Two

Flux
 Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt % is recommended.)

Recommended Temperature Profile of Infrared Reflow



(2) Dip soldering

• Temperature 260 °C or below (molten solder temperature)

• Time 10 seconds or less

Number of times
 One

• Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of

0.2 Wt % is recommended.)

(3) Cautions

Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

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CAUTION

Within this device there exists GaAs (Gallium Arsenide) material which is a harmful substance if ingested. Please do not under any circumstances break the hermetic seal.

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